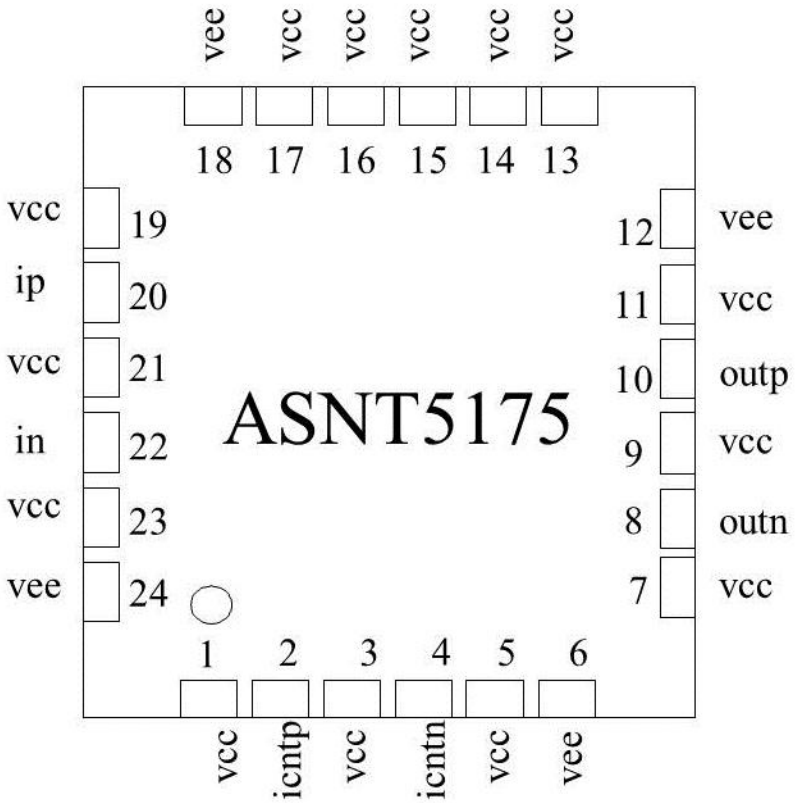
ADSANTEC
Ultra High-Speed Mixed Signal ASICs

Advanced Science And Novel Technology Company, Inc.
2790 Skypark Drive Suite 112, Torrance, CA 90505

Offices: 310-530-9400 / Fax: 310-530-9402
www.adsantec.com

ASNT5175-PQC
DC-17*Gbps*/14*GHz* Signal Phase Shifter

- Broadband (DC-17*Gbps*/DC-14*GHz*) tunable data/clock phase shifter
- Delay adjustment range of 255*ps*
- Exhibits low jitter and limited temperature variation over industrial temperature range
- 1*GHz* of bandwidth for the phase adjustment tuning port
- Fully differential CML input interfaces
- Fully differential CML output interface with 400*mV* single-ended swing
- Single +3.3*V* or -3.3*V* power supply
- Power consumption: 610*mW*
- Fabricated in SiGe for high performance, yield, and reliability
- Standard MLF/QFN 24-pin package



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DESCRIPTION

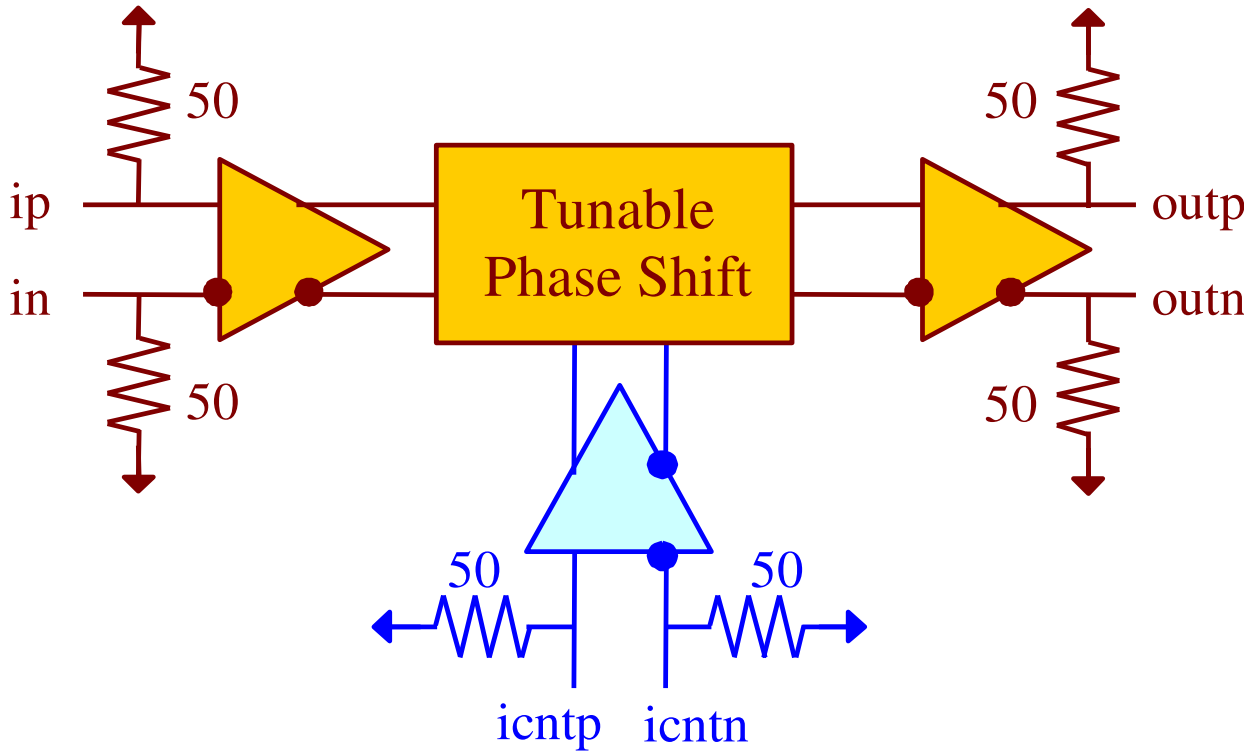


Fig. 1. Functional Block Diagram

ASNT5175-PQC is a data / clock variable delay line fabricated in SiGe technology. The IC shown in Fig. 1 provides an adjustable delay of its differential output signal outp/outn in relation to its broadband input signal ip/in. The delay is controlled through a wide-band differential tuning port icntp/icntn.

The part's I/O's support the CML logic interface with on chip 50*Ohm* termination to vcc and may be used differentially, AC/DC coupled, single-ended, or in any combination (see also POWER SUPPLY CONFIGURATION). In the DC-coupling mode, the input signal's common mode voltage should comply with the specifications shown in ELECTRICAL CHARACTERISTICS. In the AC-coupling mode, the input termination provides the required common mode voltage automatically. The differential DC signaling mode is recommended for optimal performance.

Due to an extremely low jitter, the part is suitable for use in high-speed measurement / test equipment.

Delay Control Port

The delay is controlled through a wide-band differential tuning port icntp/icntn. The delay control diagram is shown in Fig. 2.

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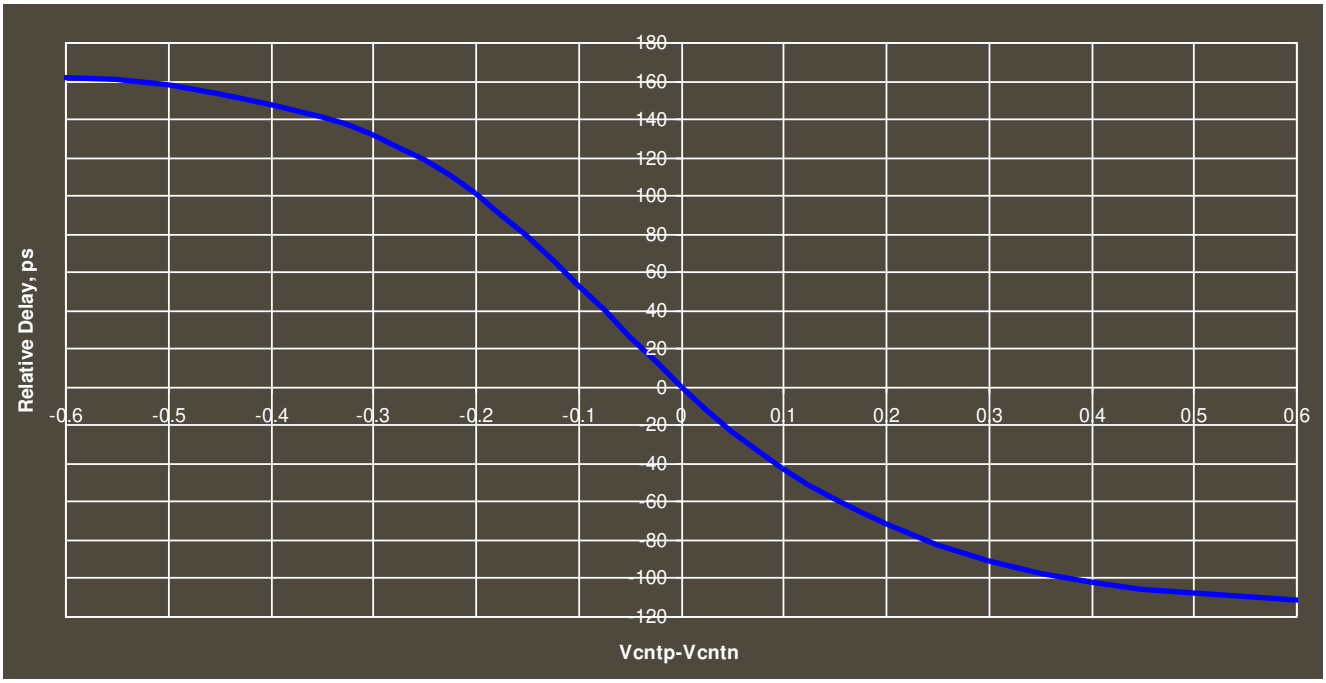


Fig. 2. Delay Control Diagram

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POWER SUPPLY CONFIGURATION

The part can operate with either a negative supply (vcc = 0.0*V* = ground and vee = −3.3*V*), or a positive supply (vcc = +3.3*V* and vee = 0.0*V* = ground). In case of a positive supply, all I/Os need AC termination when connected to any devices with 50*Ohm* termination to ground. Different PCB layouts will be needed for each different power supply combination.

All the characteristics detailed below assume vcc = 0.0*V* and vee = -3.3*V*.

ABSOLUTE MAXIMUM RATINGS

Caution: Exceeding the absolute maximum ratings shown in Table 1 may cause damage to this product and/or lead to reduced reliability. Functional performance is specified over the recommended operating conditions for power supply and temperature only. AC and DC device characteristics at or beyond the absolute maximum ratings are not assumed or implied. All min and max voltage limits are referenced to ground.

Table 1. Absolute Maximum Ratings

Parameter	Min	Max	Units
Supply Voltage (vee)		-3.6	*V*
Power Consumption		0.67	*W*
RF Input Voltage Swing (SE)		1.0	*V*
Case Temperature		+90	*ºC*
Storage Temperature	-40	+100	*ºC*
Operational Humidity	10	98	%
Storage Humidity	10	98	%

TERMINAL FUNCTIONS

TERMINAL			DESCRIPTION
Name	**No.**	**Type**	
High-Speed I/Os			
ip	20	CML input	Differential high-speed signal inputs with internal SE 50*Ohm* termination to vcc
in	22		
icntp	2	CML input	Differential low-speed control inputs with internal SE 50*Ohm* termination to vcc
icntn	4		
outp	10	CML output	Differential high-speed signal outputs with internal SE 50*Ohm* termination to vcc. Require external SE 50*Ohm* termination to vcc
outn	8		

Supply and Termination Voltages		
Name	**Description**	**Pin Number**
vcc	Positive power supply (+3.3*V* or 0)	1, 3, 5, 7, 9, 11, 13, 14, 15, 16, 17, 19, 21, 23
vee	Negative power supply (0*V* or -3.3*V*)	6, 12, 18, 24

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ELECTRICAL CHARACTERISTICS

PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
General Parameters					
vee	-3.1	-3.3	-3.5	*V*	±6%
vcc		0.0		*V*	External ground
*I*vee		185		*mA*	
Power consumption		610		*mW*	
Junction temperature	-40	25	125	*°C*	
HS Input Data/Clock (ip/in)					
Data Rate	DC		17	*Gbps*	
Frequency	DC		14	*GHz*	For clock signals
Swing	0.05		1.0	*V*	Differential or SE, p-p
CM Voltage Level	vcc-0.8		vcc	*V*	Must match for both inputs
HS Output Data/Clock (outp/outn)					
Data Rate	DC		17	*Gbps*	
Frequency	DC		14	*GHz*	For clock signals
Logic "1" level		vcc		*V*	
Logic "0" level		vcc-0.4		*V*	With external 50*Ohm* DC termination
Rise/Fall times	15		19	*ps*	20%-80%
Output Jitter			1	*ps*	Peak-to-peak
Duty cycle	45	50	55	*%*	For clock signal
Output-to-Input Delay					
Adjustment range		270		*ps*	At 1*GHz* — For the full range of icntp/icntn control signals
Adjustment range		255		*ps*	At 13*GHz*
Absolute delay stability	-32		32	*ps*	0-125°C
Phase Shift Control port (icntp/icntn)					
Bandwidth	DC		1000	*MHz*	
SE voltage level	vcc-600		vcc	*mV*	Half control range when the opposite pin is at vcc
SE voltage level	vcc-1200		vcc	*mV*	Full control range when the opposite pin is at vcc-0.6*V*
Differential swing	0		1200	*mV*	Peak-peak, full control range
CM Level		vcc-(Diff. swing)/4		*V*	In differential mode

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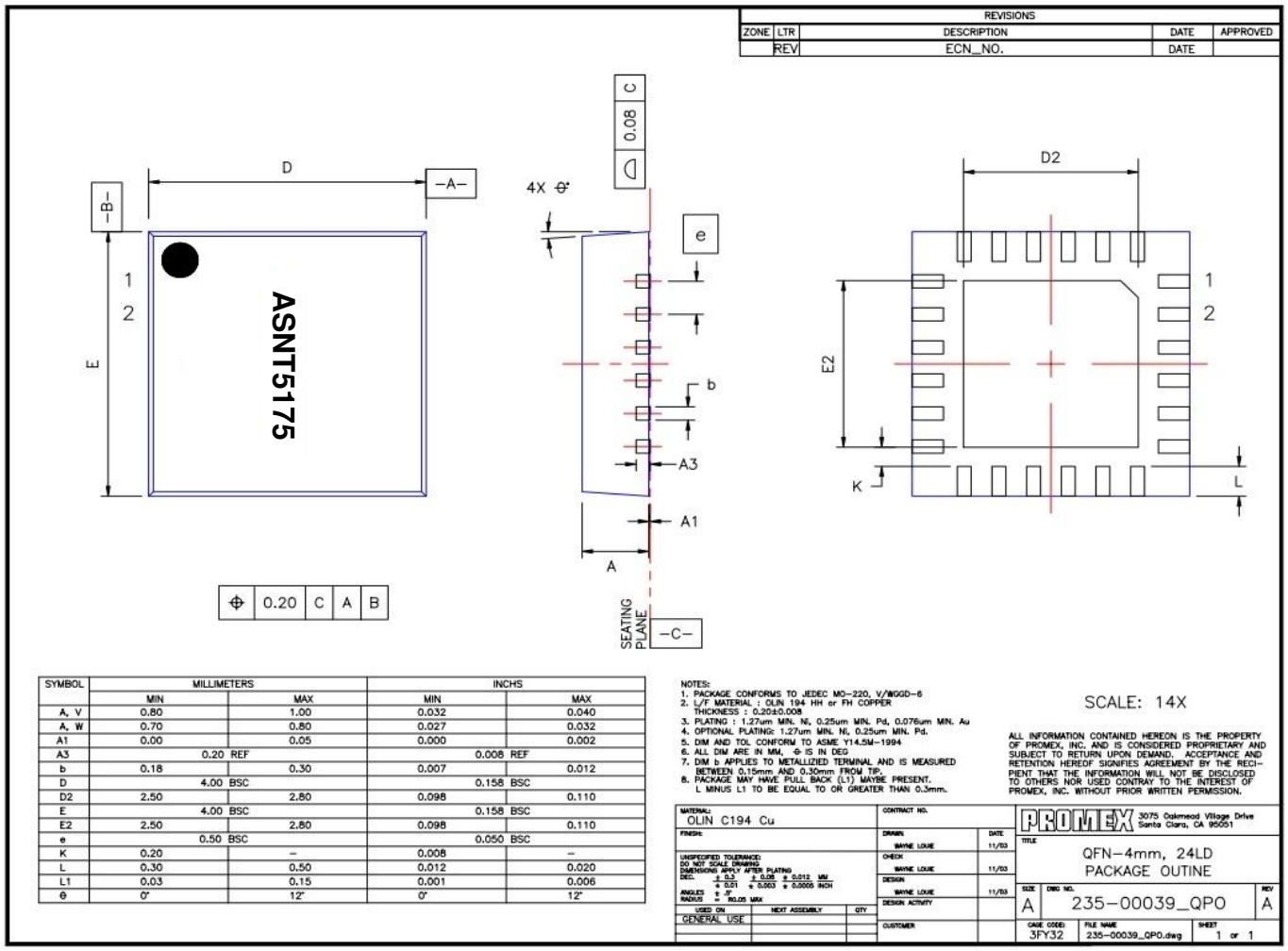
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PACKAGE INFORMATION

The chip die is housed in a standard 24-pin QFN package shown in Fig. 3. It is recommended that the center heat slug located on the back side of the package is soldered to the vee plain, which is ground for the positive supply or power for the negative supply. It will help dissipate heat generated by the chip during operation.

The part's identification label is ASNT5175-PQC. The first 8 characters of the name before the dash identify the bare die including general circuit family, fabrication technology, specific circuit type, and part version while the 3 characters after the dash represent the package's manufacturer, type, and pin out count.

This device complies with the Restriction of Hazardous Substances (RoHS) per 2011/65/EU for all ten substances.



SYMBOL	MILLIMETERS		INCHS	
	MIN	MAX	MIN	MAX
A, V	0.80	1.00	0.032	0.040
A, W	0.70	0.80	0.027	0.032
A1	0.00	0.05	0.000	0.002
A3	0.20 REF		0.008 REF	
b	0.18	0.30	0.007	0.012
D	4.00 BSC		0.158 BSC	
D2	2.50	2.80	0.098	0.110
E	4.00 BSC		0.158 BSC	
E2	2.50	2.80	0.098	0.110
e	0.50 BSC		0.050 BSC	
K	0.20	–	0.008	–
L	0.30	0.50	0.012	0.020
L1	0.03	0.15	0.001	0.006
θ	0°	12°	0°	12°

Fig. 3. QFN 24-Pin Package Drawing (all dimensions in mm)

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REVISION HISTORY

Revision	Date	Changes
6.5.2	01-2020	Updated Package Information
6.4.2	07-2019	Updated Letterhead
6.4.1	06-2013	Corrected title Corrected maximum speed value
6.3.1	05-2013	Corrected adjustment range Corrected power consumption Corrected control diagram Revised power supply configuration Corrected electrical characteristics table
6.2.1	03-2013	Corrected terminal functions Corrected phase shift values
6.1.1	03-2013	Added delay control diagram
6.0.1	02-2013	Revised package pin out drawing Revised functional block diagram Added power supply configuration Added absolute maximum ratings Revised terminal functions Revised electrical characteristics Added package information and mechanical drawing Format correction
5.0	10-2011	Revised electrical characteristics section Revised packaging information section
4.0	02-2008	Revised electrical characteristics section
3.0	06-2007	Revised electrical characteristics section
2.0	04-2007	Revised terminal functions section
1.0	01-2007	First release